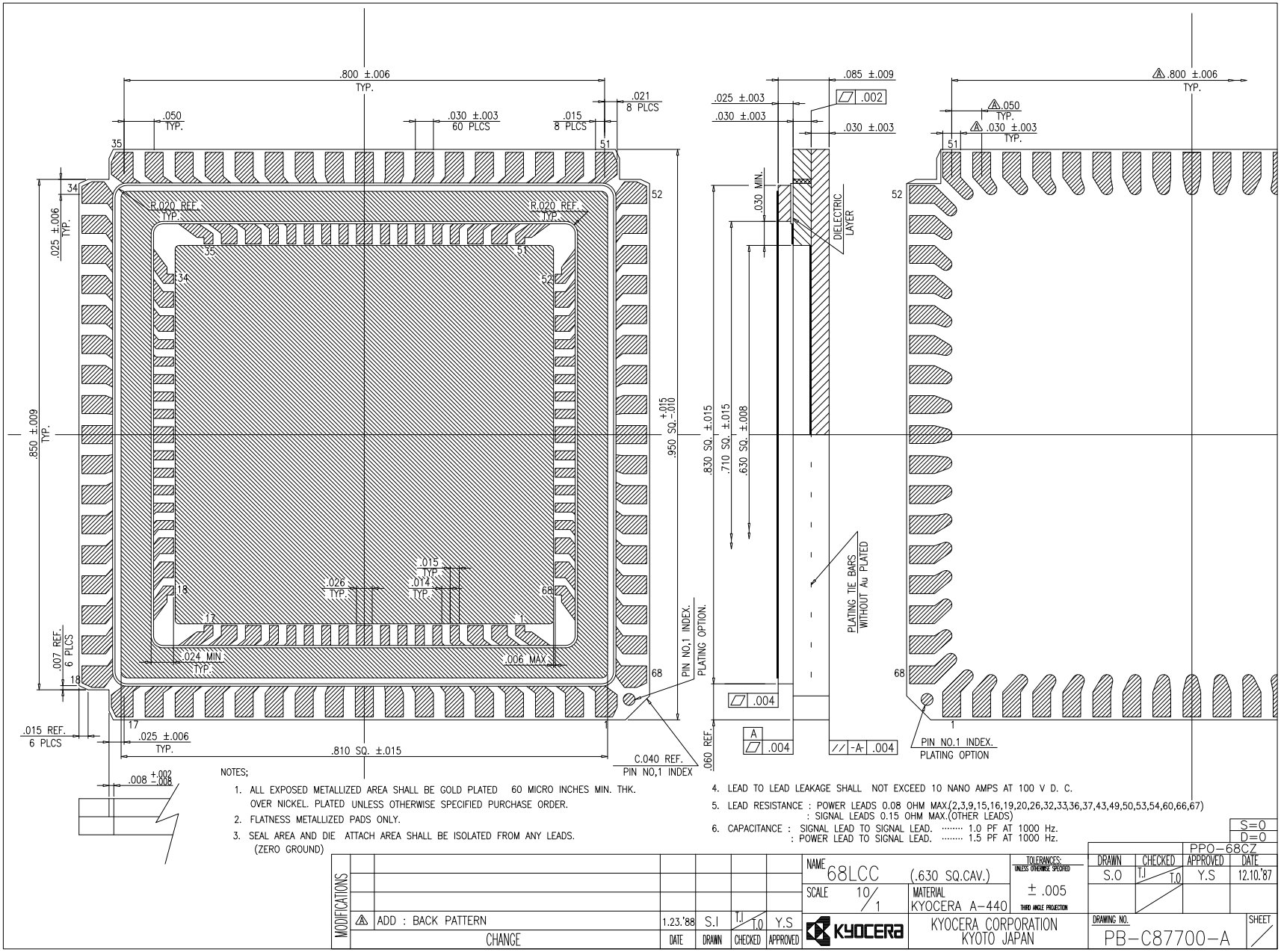
SSM P/N LCC06857



NOTES;

1. ALL EXPOSED METALLIZED AREA SHALL BE GOLD PLATED 60 MICRO INCHES MIN. THK. OVER NICKEL. PLATED UNLESS OTHERWISE SPECIFIED PURCHASE ORDER.
2. FLATNESS METALLIZED PADS ONLY.
3. SEAL AREA AND DIE ATTACH AREA SHALL BE ISOLATED FROM ANY LEADS. (ZERO GROUND)
4. LEAD TO LEAD LEAKAGE SHALL NOT EXCEED 10 NANO AMPS AT 100 V D. C.
5. LEAD RESISTANCE : POWER LEADS 0.08 OHM MAX.(2,3,9,15,16,19,20,26,32,33,36,37,43,49,50,53,54,60,66,67)
   : SIGNAL LEADS 0.15 OHM MAX.(OTHER LEADS)
6. CAPACITANCE : SIGNAL LEAD TO SIGNAL LEAD. ····· 1.0 PF AT 1000 Hz.
   : POWER LEAD TO SIGNAL LEAD. ····· 1.5 PF AT 1000 Hz.

MODIFICATIONS					
⚠ ADD : BACK PATTERN	1.23.'88	S.I	T.I	T.0	Y.S
CHANGE	DATE	DRAWN	CHECKED		APPROVED

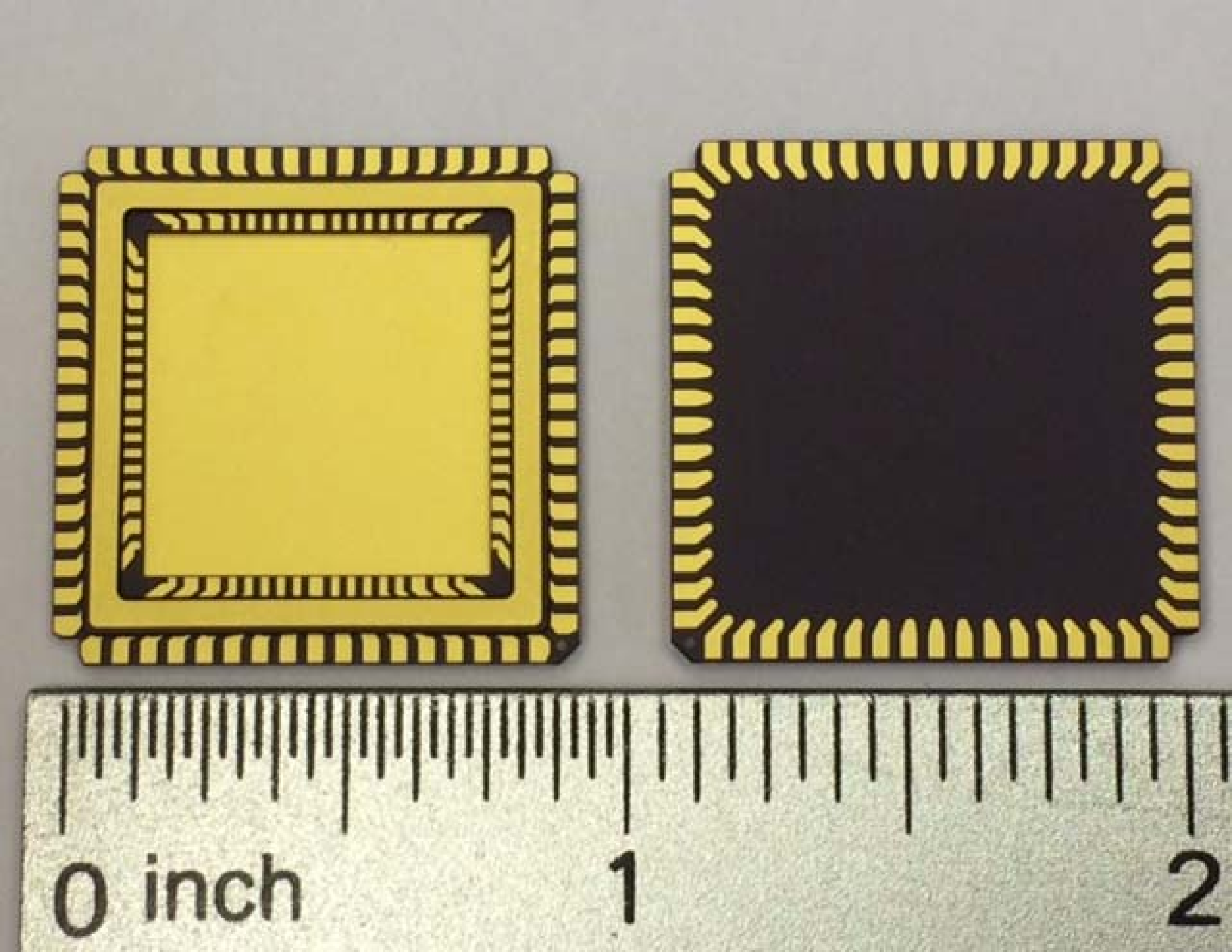
NAME 68LCC (.630 SQ.CAV.)
SCALE 10/1
MATERIAL KYOCERA A-440
TOLERANCES: UNLESS OTHERWISE SPECIFIED ± .005 THIRD ANGLE PROJECTION
KYOCERA
KYOCERA CORPORATION KYOTO JAPAN

S=0
D=0
PPO-68CZ

DRAWN	CHECKED	APPROVED	DATE
S.O	T.I / T.0	Y.S	12.10.'87

DRAWING NO. PB-C87700-A
SHEET

SPECTRUM SEMICONDUCTOR MATERIALS, INC.
Ph: 408.435.5555 email: ssm_sales@spectrum-semi.com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